

L Number	Hits	Search Text	DB	Time stamp
10	7837	damascene	USPAT; US-PGPUB	2004/06/21 10:27
11	7353	seed\$3 adj layer	USPAT; US-PGPUB	2004/06/21 10:27
12	399369	copper or Cu	USPAT; US-PGPUB	2004/06/21 10:27
13	36968	barrier adj layer	USPAT; US-PGPUB	2004/06/21 10:27
19	575534	aluminum	USPAT; US-PGPUB	2004/06/21 10:36
20	130684	tungsten	USPAT; US-PGPUB	2004/06/21 10:36
21	1030	damascene and (seed\$3 adj layer) and (copper or Cu) and aluminum and tungsten	USPAT; US-PGPUB	2004/06/21 11:29